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MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA  
22313-1450.

Dated: June 27, 2007

Signature: Richard H. Anderson  
(Richard H. Anderson)

Docket No.: 28569/38510A  
(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Mingming Fang et al.

Application No.: 10/713,709

Confirmation No.: 2098

Filed: November 14, 2003

Art Unit: 1765

For: Chemical-Mechanical Polishing (CMP) Slurry  
and Method of Planarizing Computer Memory  
Disk Surfaces

Examiner: K. C. Chen

### **RESPONSE TO RESTRICTION REQUIREMENT**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the election/restriction requirement dated June 18, 2007,  
applicants hereby elect, with traverse, the claims of Group II (claims 14-20).

It is submitted that since the elected method claims 14-20 include all of the features of the composition claims 1-13, there would be no serious burden on the Examiner to include claims 1-13 in the examination of this application.

Examination of all claims 1-20 is respectfully requested.

Dated: June 27, 2007

Respectfully submitted,

By: Richard H. Anderson

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